

Session Program

3-14 Jun 2013

TALENT Summer School

***Work Package 2: Sensors and Work Package
3: Electronics***

CERN

Monday 3 June

09:15

Work Package 2: Sensors and Work Package 3: Electronics

Session | Location: CERN, 40/S2-C01 - Salle Curie | Convener: Heinz Pernegger

09:15-10:00 **Optical data transmission in HEP**

Speaker

Tobias Flick

10:00-10:45 **Micro integration of electronics - from bump bonding to 3D stacking**

Speaker

Thomas Fritzsich

10:45